

LOC		DIST		REVISIONS			
P	LTR	DESCRIPTION		DATE	DWN	APVD	
O		REV PER EC 0512-0319-04		01JUN2005	BC	GS	
A		REV PER EC 0512-0302-05		13DEC2005	BC	GS	

D

C

B

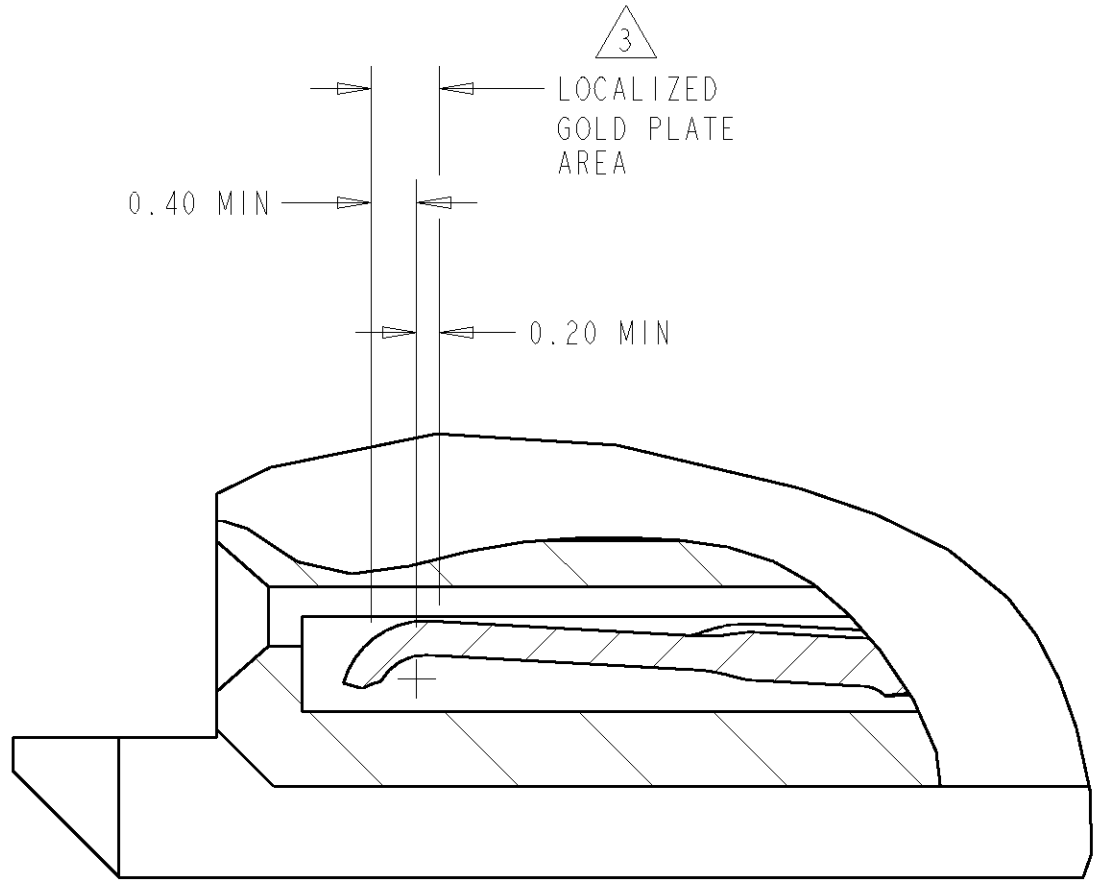
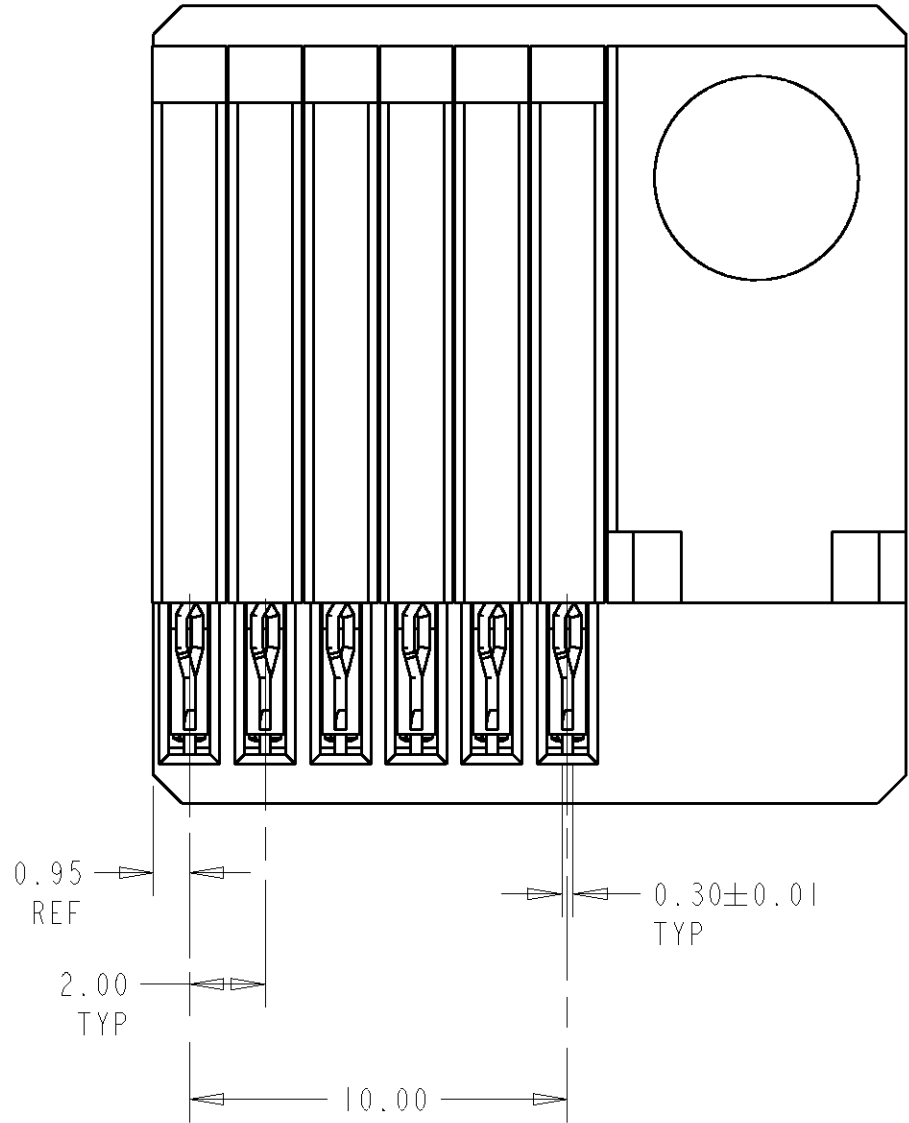
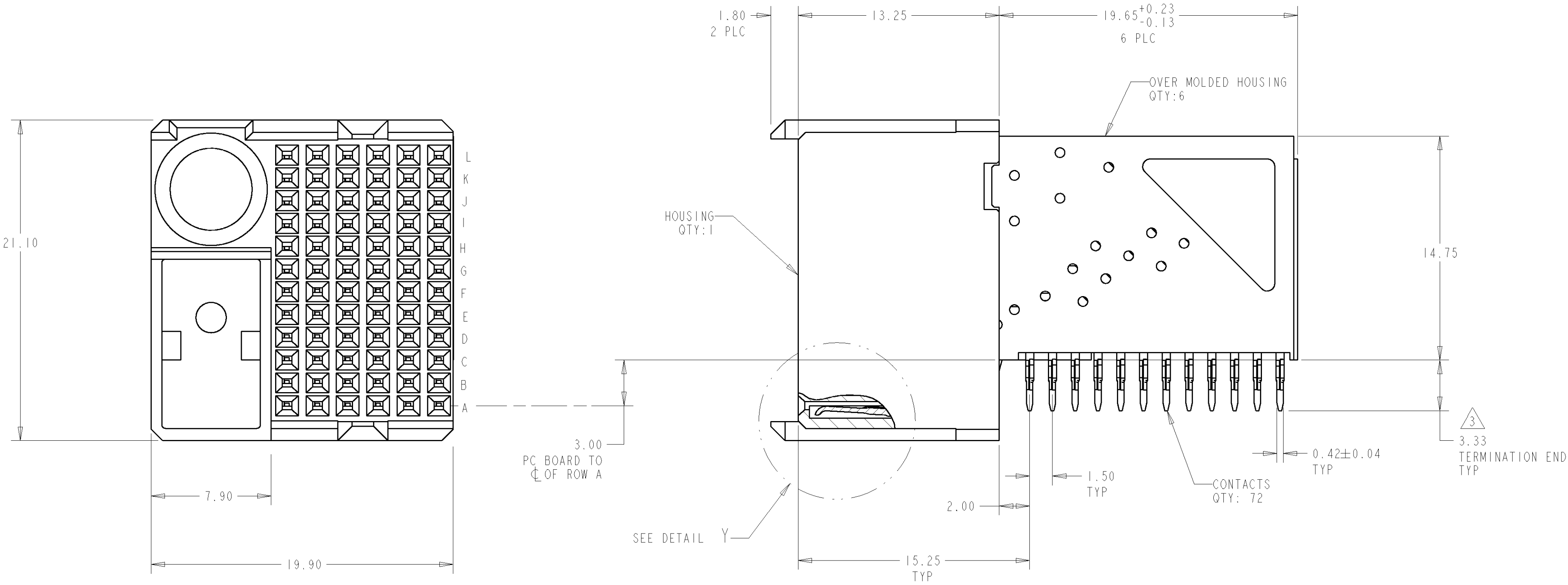
A

D

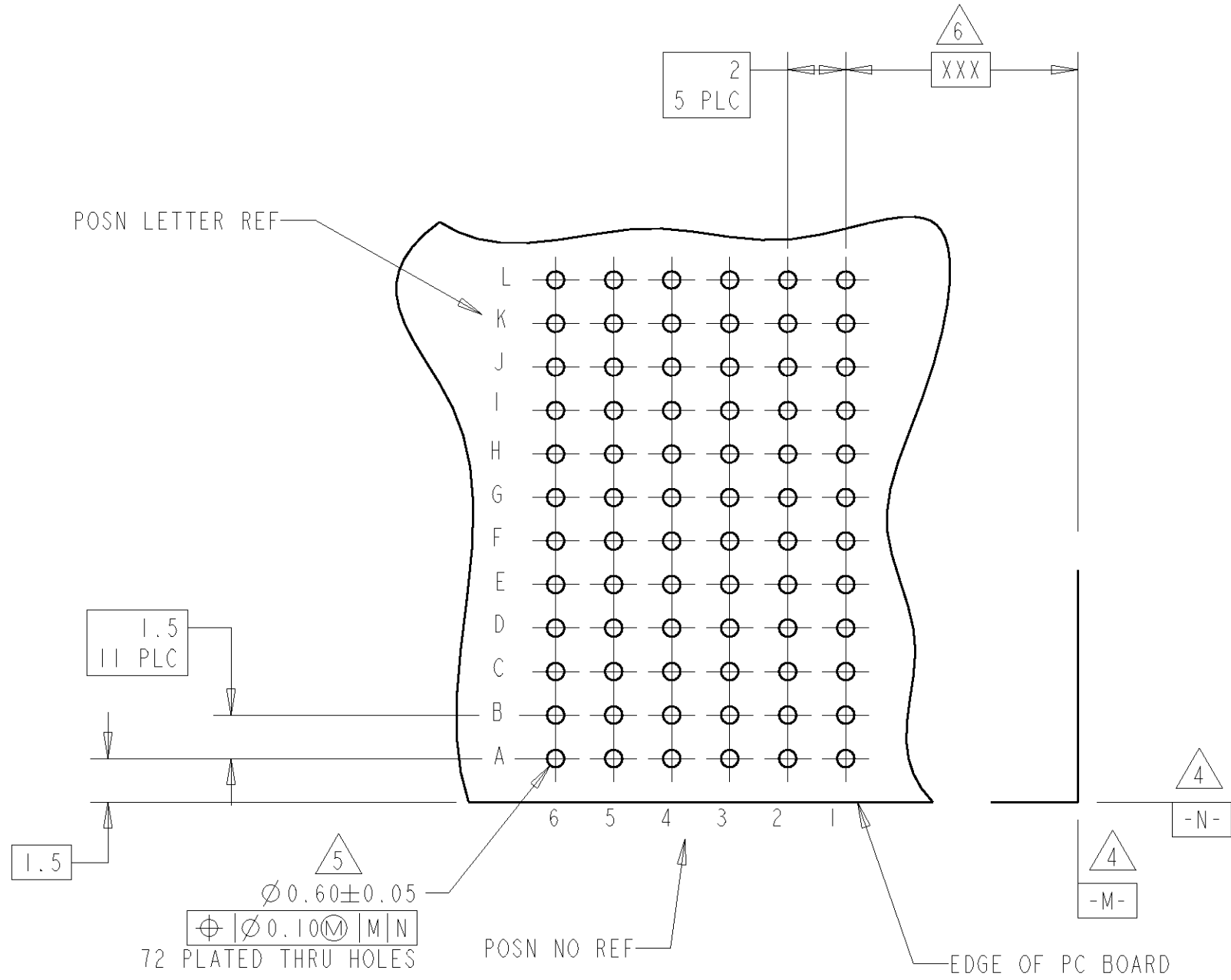
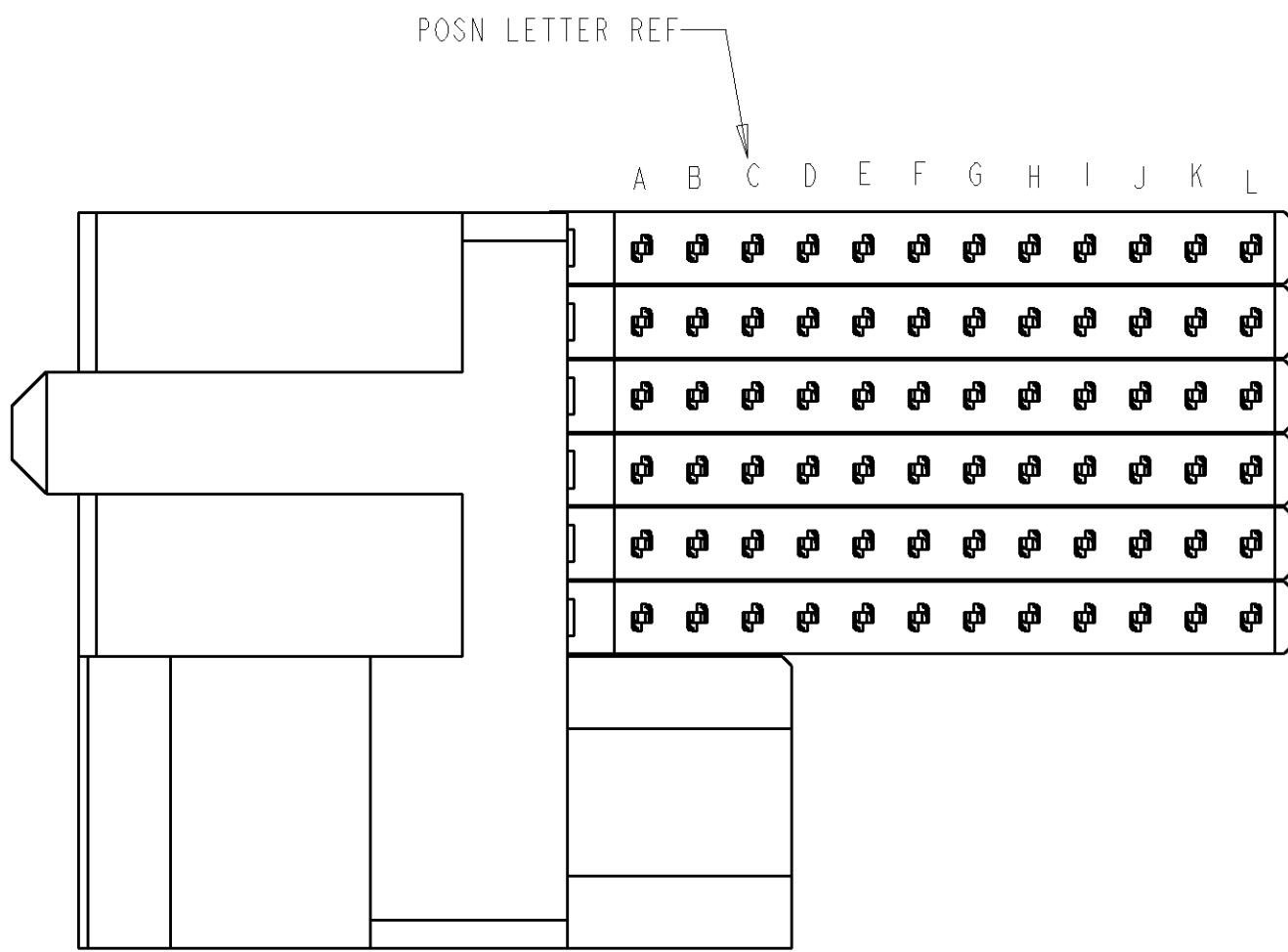
C

B

A



DETAIL Y
SCALE 15:1
TYPICAL



RECOMMENDED
PRINTED CIRCUIT BOARD
LAYOUT
RECOMMENDED PRINTED CIRCUIT BOARD
THICKNESS 1.27
COMPONENT SIDE OF PRINTED CIRCUIT BOARD

- 1 GLASS FILLED POLYESTER, BLACK
- 2 PHOSPHOR BRONZE
- 3 CONFORMS TO ALL TESTING ACCORDING TO IEC 61076-4-101 PERFORMANCE LEVEL 2.
- 4 DATUMS ESTABLISHED BY CUSTOMER.
- 5 DRILLED HOLE DIAMETER 0.700±0.025
COPPER THK 0.025-0.05
TIN THICKNESS 0.004-0.01
- 6 DIMENSION ESTABLISHED BY CUSTOMER.
- 7 GENERAL PLATING SPECIFICATION: UNDERPLATING (ENTIRE CONTACT): 1.27µm MIN NICKEL AND ACTION PIN: 0.5µm MIN TIN
FOR PLATING OF MATING SURFACES SEE APPLICABLE SPECIFICATION REFERENCE FOR EACH DASH NUMBER.

5120640-1
PART NUMBER

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DIMENSIONS:		CHK: G. SKIPPER	01JUN05		
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD: G. SKIPPER	01JUN05		
mm		PRODUCT SPEC			
9 PLC ±		APPLICATION SPEC		NAME: RECEPTACLE ASSEMBLY, SIGNAL/GROUND COMBINATION, 72 POSITION, LEFT HAND, Z-PACK 12 HM	RESTRICTED TO
1 PLC ±		WEIGHT			
3 PLC ±		CUSTOMER DRAWING			
5 PLC ±		SCALE: 5:1	SHEET: 1	OF: 1	REV: A
4 PLC ±					
ANGLES					
FINISH					
MATERIAL					
HOUSING: 1					
CONTACTS: 2					
CONTACTS: 3					
CONTACTS: 7					